

AMENDMENT UNDER 37 C.F.R. § 1.111
U.S. Appln. No. 09/830,605

4. (amended) The adhesive label according to any one of claims 1 to 3, wherein an entire data carrier element for a contactless data carrier system containing said electronic components is formed on one side of said circuit substrate, and said adhesive layer is formed on said entire data carrier element.

5. (amended) The adhesive label according to any one of claims 1 to 3, wherein a surface layer is provided on a circuit substrate surface that is on the reverse side to a surface carrying said electronic element.

6. (amended) The adhesive label according to claim 1, wherein said electronic components are separately formed on each surface of said circuit substrate and connected to each other by a through-hole to integrate both electronic components to form an entire data carrier element for a contactless data carrier system, said adhesive layer is formed on one of said separately formed electronic components, and said surface layer is formed on the other of said separately formed electronic components.

Please add the following new claim:

7. (new) The adhesive label according to claim 4, wherein a surface layer is provided on a circuit substrate surface that is on the reverse side to a surface carrying said electronic element.
